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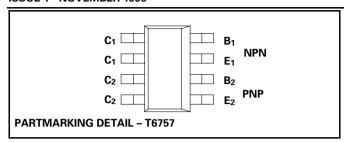




# SM-8 COMPLEMENTARY MEDIUM POWER TRANSISTORS

**ISSUE 1 - NOVEMBER 1995** 

**ZDT6757** 





#### ABSOLUTE MAXIMUM RATINGS.

PARAMETER	SYMBOL	NPN	PNP	UNIT
Collector-Base Voltage	$V_{CBO}$	300	-300	V
Collector-Emitter Voltage	$V_{CEO}$	300	-300	V
Emitter-Base Voltage	$V_{EBO}$	5	-5	V
Peak Pulse Current	I <sub>CM</sub>	1	-1	А
Continuous Collector Current	I <sub>C</sub>	0.5	-0.5	Α
Operating and Storage Temperature Range	T <sub>j</sub> :T <sub>stg</sub>	-55 to +150		°C

#### THERMAL CHARACTERISTICS

PARAMETER	SYMBOL	VALUE	UNIT
Total Power Dissipation at T <sub>amb</sub> = 25°C* Any single die "on" Both die "on" equally	P <sub>tot</sub>	2.25 2.75	W W
Derate above 25°C* Any single die "on" Both die "on" equally		18 22	mW/ °C mW/ °C
Thermal Resistance - Junction to Ambient* Any single die "on" Both die "on" equally		55.6 45.5	°C/W °C/W

<sup>\*</sup> The power which can be dissipated assuming the device is mounted in a typical manner on a PCB with copper equal to 2 inches square.

### **ZDT6757**

## NPN TRANSISTOR ELECTRICAL CHARACTERISTICS (at $T_{amb} = 25$ °C).

			<del></del>			
PARAMETER	SYMBOL	MIN.	TYP.	MAX.	UNIT	CONDITIONS.
Collector-Base Breakdown Voltage	V <sub>(BR)CBO</sub>	300			V	I <sub>C</sub> =100μA, I <sub>E</sub> =0
Collector-Emitter Breakdown Voltage	V <sub>(BR)CEO</sub>	300			V	I <sub>C</sub> =10mA, I <sub>B</sub> =0*
Emitter-Base Breakdown Voltage	V <sub>(BR)EBO</sub>	5			V	I <sub>E</sub> =100μA, I <sub>C</sub> =0
Collector Cutoff Current	I <sub>CBO</sub>			100	nA	V <sub>CB</sub> =200V, I <sub>E</sub> =0
Emitter Cutoff Current	I <sub>EBO</sub>			100	nA	V <sub>EB</sub> =3V, I <sub>C</sub> =0
Collector-Emitter Saturation Voltage	V <sub>CE(sat)</sub>			0.5	V	I <sub>C</sub> =100mA, I <sub>B</sub> =10mA*
Base-Emitter Saturation Voltage	V <sub>BE(sat)</sub>			1	V	I <sub>C</sub> =100mA, I <sub>B</sub> =10mA*
Base-Emitter Turn-On Voltage	V <sub>BE(on)</sub>			1	V	I <sub>C</sub> =100mA, V <sub>CE</sub> =5V*
Static Forward Current Transfer Ratio	h <sub>FE</sub>	50 40				I <sub>C</sub> =100mA, V <sub>CE</sub> =5V I <sub>C</sub> =10mA, V <sub>CE</sub> =5V
Transition Frequency	f <sub>T</sub>	30			MHz	I <sub>C</sub> =10mA, V <sub>CE</sub> =20V f=20MHz
Output Capacitance	C <sub>obo</sub>			20	pF	V <sub>CB</sub> =20V, f=1MHz

<sup>\*</sup>Measured under pulsed conditions. Pulse width= $300\mu s$ . Duty cycle  $\leq 2\%$  For typical characteristics graphs see FZT657 datasheet.

### **ZDT6757**

PNP TRANSISTOR ELECTRICAL CHARACTERISTICS (at T<sub>amb</sub> = 25°C unless otherwise stated).

PARAMETER	SYMBOL	MIN.	TYP.	MAX.	UNIT	CONDITIONS.
Collector-Base Breakdown Voltage	V <sub>(BR)CBO</sub>	-300			V	I <sub>C</sub> =-100μA, I <sub>E</sub> =0
Collector-Emitter Breakdown Voltage	V <sub>(BR)CEO</sub>	-300			V	I <sub>C</sub> =-10mA, I <sub>B</sub> =0*
Emitter-Base Breakdown Voltage	V <sub>(BR)EBO</sub>	-5			V	I <sub>E</sub> =-100μA, I <sub>C</sub> =0
Collector Cutoff Current	I <sub>CBO</sub>			-100	nA nA	V <sub>CB</sub> =-160V, I <sub>E</sub> =0 V <sub>CB</sub> =-200V, I <sub>E</sub> =0
Emitter Cutoff Current	I <sub>EBO</sub>			-100	nA	V <sub>EB</sub> =-3V, I <sub>C</sub> =0
Collector-Emitter Saturation Voltage	V <sub>CE(sat)</sub>			-0.5	V	I <sub>C</sub> =-100mA, I <sub>B</sub> =-10mA*
Base-Emitter Saturation Voltage	V <sub>BE(sat)</sub>			-1.0	V	I <sub>C</sub> =-100mA, I <sub>B</sub> =-10mA*
Base-Emitter Turn-On Voltage	V <sub>BE(on)</sub>			-1.0	V	I <sub>C</sub> =-100mA, V <sub>CE</sub> =-5V*
Static Forward Current Transfer Ratio	h <sub>FE</sub>	50 40				I <sub>C</sub> =-100mA, V <sub>CE</sub> =-5V* I <sub>C</sub> =-10mA, V <sub>CE</sub> =-5V*
Transition Frequency	f <sub>T</sub>	30			MHz	I <sub>C</sub> =-10mA, V <sub>CE</sub> =-20V f=20MHz
Output Capacitance	C <sub>obo</sub>			20	pF	V <sub>CB</sub> =-20V, f=1MHz

<sup>\*</sup>Measured under pulsed conditions. Pulse width=300 $\mu$ s. Duty cycle  $\leq$  2% For typical characteristics graphs see FZT757 datasheet.